

L Number	Hits	Search Text	DB	Time stamp
1	0	(embedded near5 sensor) and (metal near5 emb dded) and (adhesive near5 layer) and (adhesive near5 titanium)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:02
2	0	(embedded near5 sensor) and (metal near5 embedded) and (adhesive near5 layer) and ((adhesive or melt or bond) near5 titanium)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:03
3	0	(embedded near5 sensor near5 metal) and (adhesive near5 layer) and ((adhesive or melt or bond) near5 titanium)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:03
4	0	(embedded near5 sensor near5 metal) and (adhesive near5 layer) and ((adhesive or melt or epoxy near5 bond) near5 titanium)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:04
5	0	(embedded near5 sensor near5 metal) and (adhesive near5 layer) and (titanium near5 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:05
6	91	embedded near5 sensor near5 metal	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:26
7	0	(embedded near5 sensor near5 metal) and (titanium near5 adhesive)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:06
8	4	(embedded near5 sensor near5 metal) and ((adhesive or epoxy or resin) near5 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:09
9	0	385/12.ccls. and ((adhesive or epoxy or resin) near5 layer near5 titanium)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:10
10	925	titanium near4 adhesive	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:11
11	0	titanium near4 adhesive and (embedded near5 sensor)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:11
12	90	titanium near4 adhesive and sensor	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:11
13	90	(titanium near4 adhesive) and sensor	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:12
16	1	"6196059"	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:57
17	1	("4788406").PN.	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:59
18	1	("4928513").PN.	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:18
19	1	("5996219").PN.	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:18

20	0	embedded near5 sensor near7 metal and constanan	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:26
21	0	embedded near5 sensor near7 metal and constantan	USPAT; US-P PUB; EPO; JPO	2002/11/05 18:30
22	0	embedded near5 sensor near7 metal and constanan	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:31
23	2	constanan	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:32
24	0	metal near4 embedded near5 sensor and (substrate near5 steel) and stainless	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:32
25	0	(metal near4 embedded near5 sensor) and (substrate near5 steel) and stainless	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:33
26	1	(embedded near5 sensor) and (substrate near5 steel) and stainless and metal	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:37
27	0	(optic\$ near5 sensor) and embed\$ and (titanium near5 adhesive)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:38
28	14	(optic\$ near5 sensor) and (titanium near5 adhesive)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:41
29	18728	(optic\$ near5 sensor) and embed\$ (layer near5 adhesive) and (insulat\$ near4 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:42
30	49	(optic\$ near5 sensor) and embed\$ and (layer near5 adhesive) and (insulat\$ near4 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:47
31	3	385/12.ccls. and (insulat\$ near5 layer) and (adhesive near5 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:51
32	0	385/12.ccls. and (insulat\$ near5 layer near6 adhesive)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:51
33	38	(optic\$ near5 sensor) and (insulat\$ near5 layer near6 adhesive)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:59
34	1	("5315245").PN.	USPAT; US-PGPUB; EPO; JPO	2002/11/05 19:01
35	1	("4788406").PN.	USPAT; US-PGPUB; EPO; JPO	2002/11/05 19:29
36	1	("4928513").PN.	USPAT; US-PGPUB; EPO; JPO	2002/11/05 19:29

-	1120	(385/12).cccls.	USPAT; US-PGPUB; EPO; JPO	2002/11/05 10:14
-	82	(385/12).cccls. and metal and melt\$	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:00
-	20	(385/12).cccls. and (metal or metallic) and melt\$ and deposition	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:01
-	24	(385/12).cccls. and (metal or metallic) and melt\$ and (deposition or sputtering or electroplating)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:02
-	17	(385/12).cccls. and (metal or metallic) and melt\$ and (deposition or sputtering or electroplating) and layer	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:05
-	81	(385/12).cccls. and (metal or metallic) and (melt\$ or temperature) and (deposition or sputtering or electroplating) and layer	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:06
-	17	(385/12).cccls. and (metal or metallic) and (melt\$) and (deposition or sputtering or electroplating) and layer	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:28
-	65644	((optic or optical) near5 sensor)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:29
-	1738	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point))	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:30
-	414	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:31
-	414	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:32
-	414	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/05 17:00
-	255	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:33
-	205	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating) and (nickel or copper or iron or platinum)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:34
-	155	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating) and (nickel or copper or iron or platinum) and (adhesive or titanium)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:35

-	61	((optic or optical) near5 sensor) and (m It\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating) and (nickel or copper or iron or platinum) and (adhesive or titanium) and (insulat\$ near5 layer)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:36
-	31	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating) and (nickel or copper or iron or platinum) and ((adhesive or titanium) near5 layer) and (insulat\$ near5 layer) and substrate	USPAT; US-PGPUB; EPO; JPO	2002/11/01 10:42
-	31	((optic or optical) near3 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating) and (nickel or copper or iron or platinum) and ((adhesive or titanium) near5 layer) and (insulat\$ near5 layer) and substrate	USPAT; US-PGPUB; EPO; JPO	2002/11/01 11:09
-	5	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating) and (nickel or copper or iron or platinum) and ((adhesive or titanium) near5 layer) and (insulat\$ near5 layer) and substrate and ((sensor).ti. or (sensor).ab.)	USPAT; US-PGPUB; EPO; JPO	2002/11/01 12:36
-	95	metal near4 embedded near5 sensor	USPAT; US-PGPUB; EPO; JPO	2002/11/05 18:32
-	14	(metal near4 embedded near5 sensor) and (melt\$ near4 (point or temperature))	USPAT; US-PGPUB; EPO; JPO	2002/11/01 13:01
-	14	(metal near4 embed\$ near5 sensor) and (melt\$ near4 (point or temperature))	USPAT; US-PGPUB; EPO; JPO	2002/11/01 13:01
-	1	("5996219").PN.	USPAT; US-PGPUB; EPO; JPO	2002/11/05 11:22
-	21	invar near5 adhesive	USPAT; US-PGPUB; EPO; JPO	2002/11/05 11:22